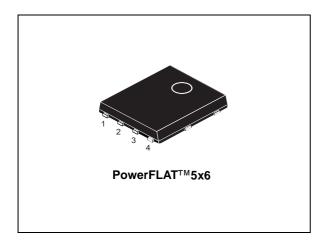
STL110NS3LLH7

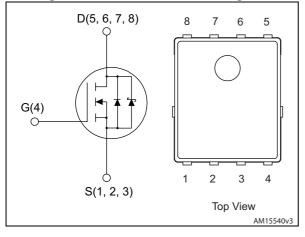
Datasheet - production data

N-channel 30 V, 0.0027 Ω typ., 120 A STripFET[™] H7 Power MOSFET plus monolithic Schottky in a PowerFLAT[™] 5x6



life.augmented

Figure 1. Internal schematic diagram



Features

Order code	V_{DS}	R _{DS(on)} max	I _D
STL110NS3LLH7	30 V	0.0034 Ω	120 A

- Very low on-resistance
- Very low Q_g
- High avalanche ruggedness
- Embedded Schottky diode

Applications

• Switching applications

Description

This device exhibits low on-state resistance and capacitance for improved conduction and switching performance.

Table 1. Device summary

Order code	Marking	Package	Packing
STL110NS3LLH7	110NS3LL	PowerFLAT [™] 5x6	Tape and reel

This is information on a product in full production. This is information on a product in full production.

Contents

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3	Test circuits
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1

Electrical ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	30	V
V _{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous)	120	Δ
ID, ,	Drain current (continuous) at T _C = 100 °C	75	A
I _{DM} ⁽¹⁾⁽²⁾	Drain current (pulsed)	480	Α
I _D ⁽³⁾	Drain current (continuous)	28	Δ
	Drain current (continuous) at T _{pcb} = 100 °C	17.5	A
I _{DM} ⁽²⁾⁽³⁾	Drain current (pulsed)	112	А
	Total dissipation at T _C = 25 °C	75 ⁽¹⁾	10/
P _{TOT}	Total dissipation at $T_{pcb} = 25 \text{ °C}$	4 ⁽³⁾	W
T _{stg}	Storage temperature		°C
T _j Operating junction temperature		-55 to 150	

Table 2. Absolute maximum ratings

1. This value is rated according to ${\sf R}_{thj\text{-}c}$

2. Pulse width limited by safe operating area.

3. This value is rated according to $R_{thj-pcb}$

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb max	31.3	°C/W
R _{thj-case}	Thermal resistance junction-case max	1.65	°C/W

1. When mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 sec



2 Electrical characteristics

$(T_C = 25 \text{ °C unless otherwise specified})$)
----------------------------------------------------	---

Table 4. Static						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0 V	30			V
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V V _{DS} = 24 V			500	μA
I _{GSS}	Gate-body leakage current	$V_{GS} = \pm 20$ V, $V_{DS} = 0$ V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1.2		2.3	V
D	Static drain-source	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 14 \text{ A}$		0.0027	0.0034	Ω
R _{DS(on)}	on-resistance	$V_{GS} = 4.5 \text{ V}, I_D = 14 \text{ A}$		0.004	0.005	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	2110	-	pF
C _{oss}	Output capacitance	V _{DS} = 25 V, f = 1 MHz,	-	640	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0 V	-	42	-	pF
Qg	Total gate charge	V _{DD} = 15 V, I _D = 28 A,	-	13.7	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 4.5 V	-	7.5	-	nC
Q _{gd}	Gate-drain charge	(see Figure 11)	-	3.3	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	26.4	-	ns
t _r	Rise time	V _{DD} = 15 V, I _D = 14 A,	-	10.4	-	ns
t _{d(off)}	Turn-off delay time	R_{G} = 4.7 Ω, V_{GS} = 4.5 V	-	31.8	-	ns
t _f	Fall time		-	12.5	-	ns



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{SD} ⁽¹⁾	Forward on voltage $I_{SD} = 2 \text{ A}, V_{GS} = 0 \text{ V}$		-	0.4	0.7	V
t _{rr}	Reverse recovery time		-	35.2		ns
Q _{rr}	Reverse recovery charge	I _D = 2 A, di/dt = 100 A/µs V _{DD} = 20 V	-	26.4		nC
I _{RRM}	Reverse recovery current		-	1.5		А

Table 7. Source drain diode

1. Pulsed: pulse duration = $300 \ \mu$ s, duty cycle 1.5%



2.1 Electrical characteristics (curves)

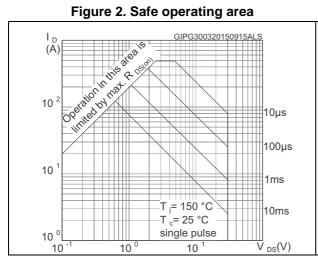
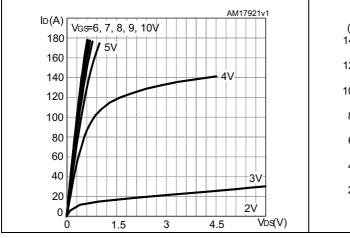
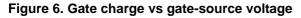


Figure 4. Output characteristics





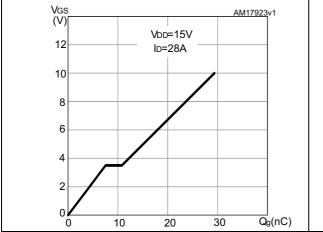


Figure 5. Transfer characteristics

10

δ = 0.05

δ = 0.02

δ = 0.01

single pulse

10

Figure 3. Thermal impedance

K

10 -

10 -2

10 -5

δ = 0.5

δ = 0.2

δ = 0.1

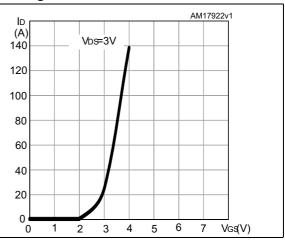
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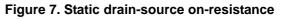
 $Z_{th}=K^*R_{thj}$ $\delta=t_p/T$

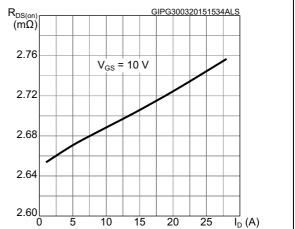
-t₀ ⊑

t_p(s)

10 -2









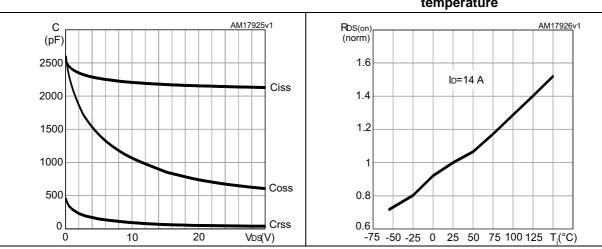
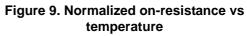
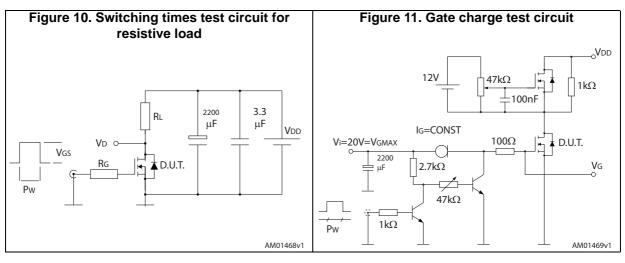


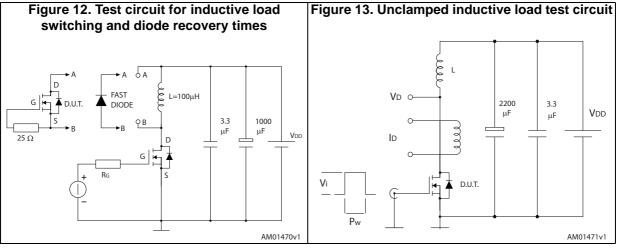
Figure 8. Capacitance variations

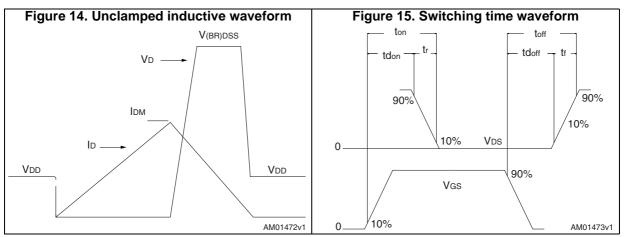




3 Test circuits









4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 PowerFLAT[™] 5x6 type C package information

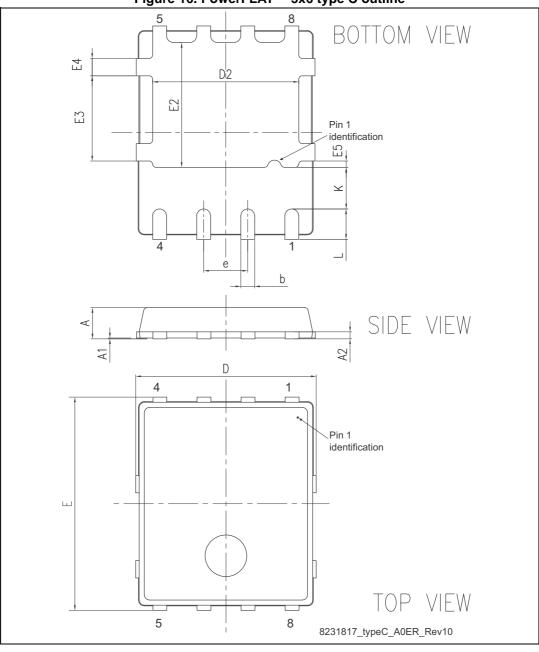


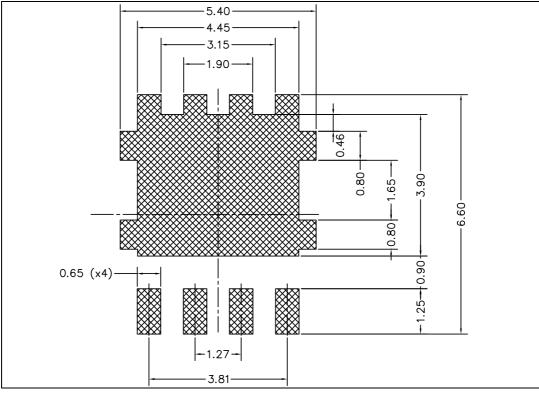
Figure 16. PowerFLAT™ 5x6 type C outline



Table 0.1 Owert LAT 5x0 type 0 mechanical data			
Dim.		mm	
Din.	Min.	Тур.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D		5.20	
E		6.15	
D2	4.11		4.31
E2	3.50		3.70
е		1.27	
e1		0.65	
L	0.715		1.015
К	1.05		1.35
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28

Table 8. PowerFLAT[™] 5x6 type C mechanical data





10/14



4.2 Packing information

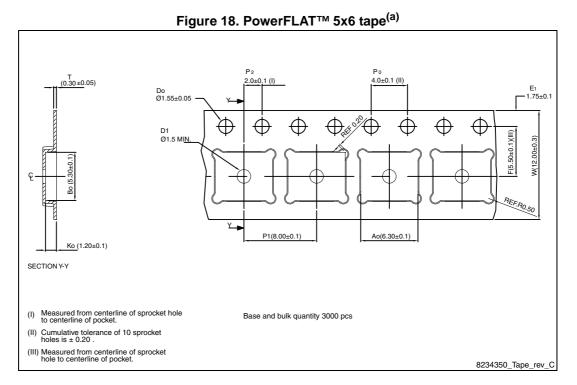
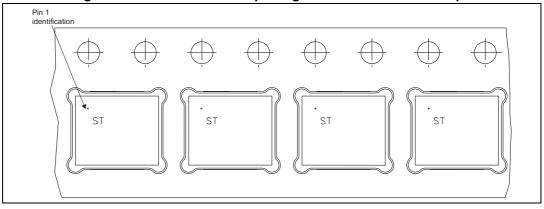
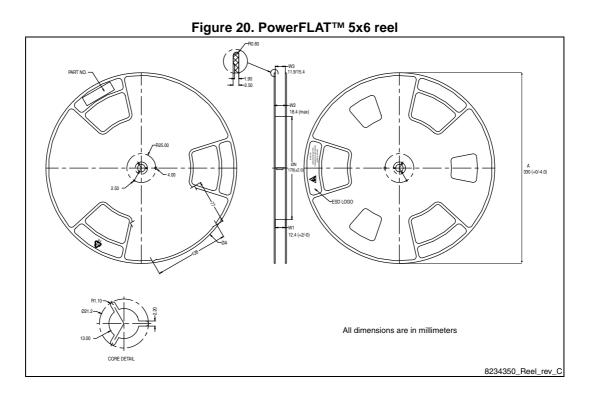


Figure 19. PowerFLAT™ 5x6 package orientation in carrier tape



a. All dimensions are in millimeters.







5 Revision history

Date	Revision	Changes
22-Apr-2013	1	First release.
11-Jun-2013	2	Changed: <i>Description</i> Minor text changes
01-Apr-2015	3	Minor text edits throughout document On cover page: – updated product description – updated features table and features list In Section 1: Electrical ratings: – updated Table 2 and Table 3 In Section 2: Electrical characteristics: – updated Table 7 Added Section 2.1: Electrical characteristics (curves) Updated Section 4: Package information
10-Apr-2015	4	Promoted document from 'Preliminary data' to 'Production data'

Table 9. Document revision history



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